

Vishay Siliconix

# N-Channel 25-V (D-S) MOSFET

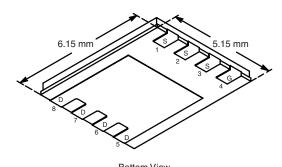
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
25	0.0017 at V <sub>GS</sub> = 10 V	60	42.5 nC		
	0.0021 at V <sub>GS</sub> = 4.5 V	60	42.3110		

#### **FEATURES**

- Halogen-free
- TrenchFET<sup>®</sup> Gen III Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % Avalanche Tested



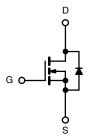
#### PowerPAK® SO-8



Ordering Information: SiR476DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **APPLICATIONS**

- · VRM, POL, Server
- High Current DC/DC
- Low-Side
- OR-ing



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	25	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	<u> </u>	
	T <sub>C</sub> = 25 °C		60 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	$T_C = 70  ^{\circ}C$	I <sub>D</sub>	60 <sup>a</sup>	A	
Committees Brain Carrent (1) = 100 °C)	T <sub>A</sub> = 25 °C	ں.	45 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		36 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	100	<b>7</b> *	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	60 <sup>a</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'S	5.6 <sup>b, c</sup>		
Single Pulse Avalanche Current  Single Pulse Avalanche Energy  L = 0.1 mH		I <sub>AS</sub>	50		
		E <sub>AS</sub>	125	mJ	
	T <sub>C</sub> = 25 °C		104		
Maximum Dawar Dissination	T <sub>C</sub> = 70 °C	P <sub>D</sub>	66.6	W	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	' D	6.25 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		4.0 <sup>b, c</sup>	1	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature	Ţ.	260			

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	0.9	1.2	]	

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 54 °C/W.

# SiR476DP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	<u> </u>			, ,,			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$	25			٧	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Vps/Ti		23			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 6.3		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V			1		
		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0014	0.0017	Ω	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A		0.00175	0.0021		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A		98		S	
Dynamic <sup>b</sup>	<u> </u>						
Input Capacitance	C <sub>iss</sub>			6150		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1510			
Reverse Transfer Capacitance	C <sub>rss</sub>			640			
	$V_{DS} = 10 \text{ V, } V_{GS} =$	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		89	135	nC	
Total Gate Charge				42.5	64		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		16			
Gate-Drain Charge	Q <sub>gd</sub>			12			
Gate Resistance	$R_{g}$	f = 1 MHz	0.2	1.0	2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	40	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_L = 1 \Omega$		9	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		48	90		
Fall Time	t <sub>f</sub>			9	18		
Turn-On Delay Time	t <sub>d(on)</sub>			50	90		
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_L = 1 \Omega$		31	60		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		60	100		
Fall Time	t <sub>f</sub>			48	90		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			60	^	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				100	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A		0.73	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			43	80	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1 40 A 41/44 400 A / - T 05 00		40	80	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		21			
Reverse Recovery Rise Time	t <sub>b</sub>			22		ns	

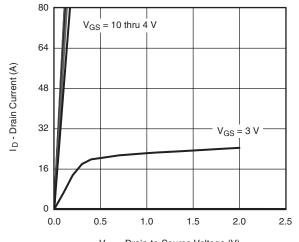
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



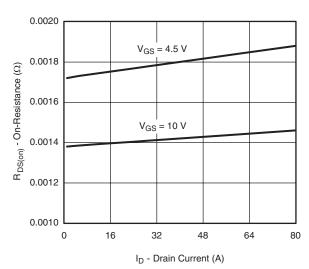
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

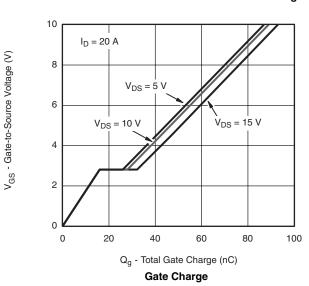


 $V_{\text{DS}}$  - Drain-to-Source Voltage (V)

#### **Output Characteristics**

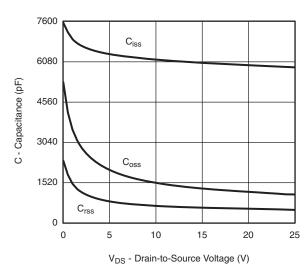


On-Resistance vs. Drain Current and Gate Voltage

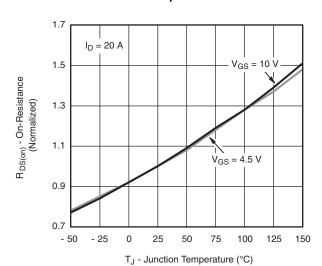


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V<sub>GS</sub> - Gate-to-Source Voltage (V) **Transfer Characteristics** 



Capacitance



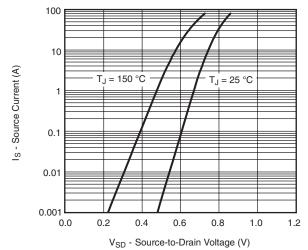
On-Resistance vs. Junction Temperature

# SiR476DP

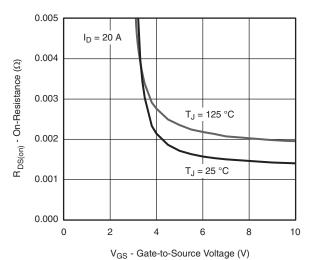
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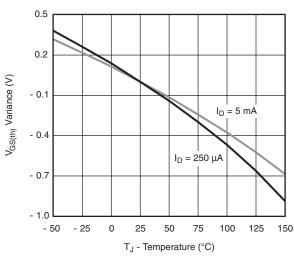
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



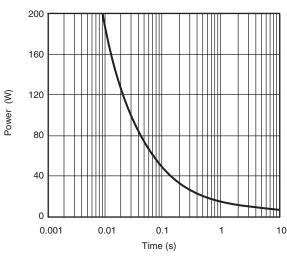
Source-Drain Diode Forward Voltage



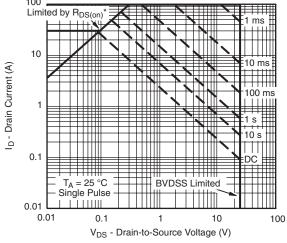
On-Resistance vs. Gate-to-Source Voltage







Single Pulse Power, Junction-to-Ambient



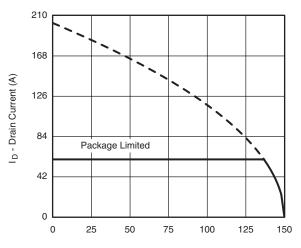
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient



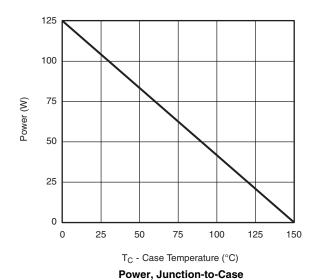
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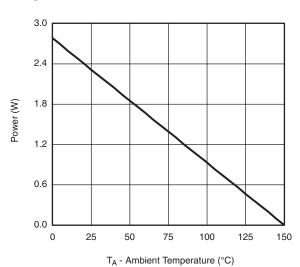
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T<sub>C</sub> - Case Temperature (°C)

#### **Current Derating\***





Power, Junction-to-Ambient

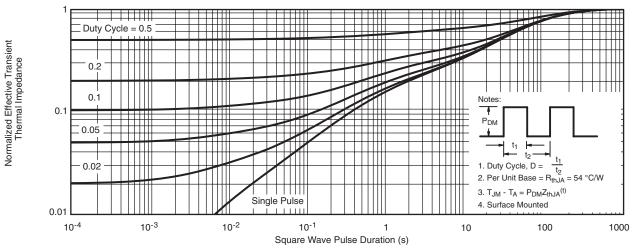
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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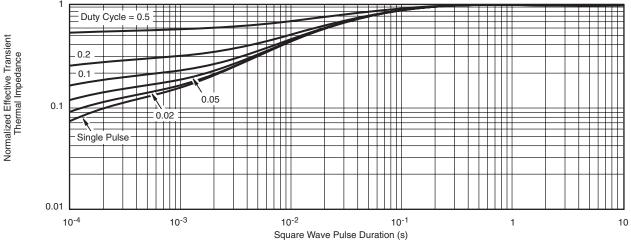
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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